

RESPONSE UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 2815

PATENT APPLICATION  
Docket No.: 9898-341  
Client Ref. No.: SS-18733-US-RCE

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Dong-Kil SHIN, et al.

Serial No.: 10/772,651 Examiner: Warren, Matthew E.

Filed: February 4, 2004 Group Art Unit: 2815

Confirmation No.: 5815

For: MULTI-CHIP PACKAGE WITH SOFT ELEMENT AND METHOD OF  
MANUFACTURING THE SAME

Date: August 3, 2007

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116**

Responsive to the Final Office Action, Paper No. 20061122, dated June 4, 2007, please amend the application as follows.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 6 of this paper.